

Silicon Carbide Schottky Barrier Diode

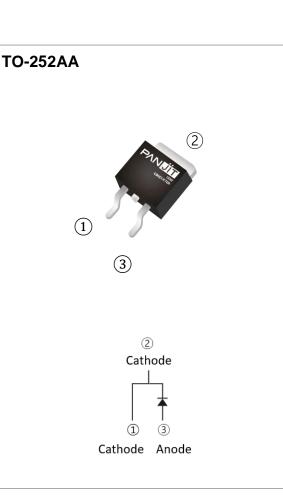


Features

- Temperature Independent Switching Behavior
- High Surge Current Capability
- Competitive VF 1.3V at rated current
- Low Conduction Loss
- Zero Reverse Recovery
- High junction temperature 175 °C
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

- Case: TO-252AA molded plastic
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.3217 grams



Application

• PFC, UPS, PV Inverter, PD charger, LED lighting

Maximum Ratings and Thermal Characteristics (T_c = 25 °C unless otherwise specified)

PARAMETE	SYMBOL	LIMIT	UNITS		
Repetitive Peak Reverse Voltage	Vrrm	650	V		
DC Blocking Voltage	V _{DC}	650	V		
Continuous Forward Current	Tc= 155 °C	IF	8	А	
Repetitive Peak Surge Current	$T_{C}=25 \circ C$, $t_{p}=10 ms$		38	A	
Half Sine Wave, D=0.1	$T_C=125 \ ^{\circ}C$, $t_p =10ms$	IFRM	30		
Peak Forward Surge Current	$T_C= 25 \circ C$, $t_p = 10 ms$		52	А	
Half Sine Wave	$T_C=125 \circ C$, $t_p =10ms$		44		
Peak Forward Surge Current $t_p = 10us$, Pulse	IFSM	600	А		
Maximum Power Dissipation	P _{total}	89	W		
Operating Junction Temperature Ra	TJ	-55~175	°C		
Storage Temperature Range	Tstg	-55~175	°C		

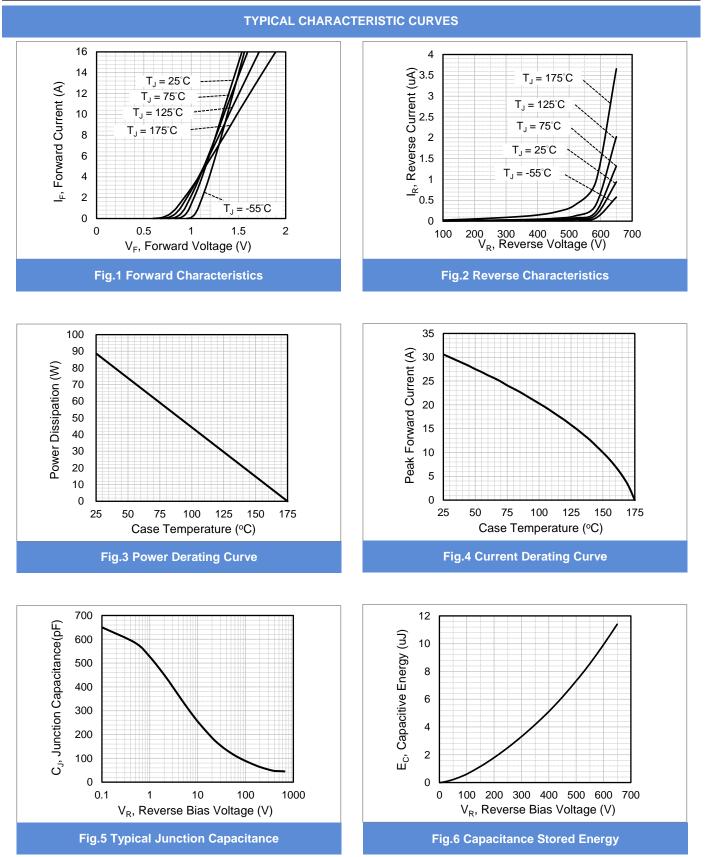


Electrical Characteristics ($T_c = 25$ °C unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Forward Voltage Drop	VF	I _F = 8 A, T _J = 25 °C	-	1.3	1.6	V	
		I _F = 8 A, T _J = 175 °C	-	1.4	-		
Reverse Leakage Current	IR	V _R = 650 V, T _J = 25 °C	-	0.9	60	μA	
		V _R = 650 V, T _J = 175 °C	-	4	-	μA	
Total Capacitive Charge	Qc	V _R = 400V	-	32	-	nC	
Total Capacitance	С	V _R = 1V, f = 1MHz	-	527	-	pF	
		V _R = 200V, f = 1MHz	-	63	-	pF	
		V _R = 400V, f = 1MHz	-	47	-	pF	
Capacitance Stored Energy	Ec	V _R = 400V	-	5.1	-	μJ	
Thermal Resistance	Rejc		-	1.69	-	°C/W	





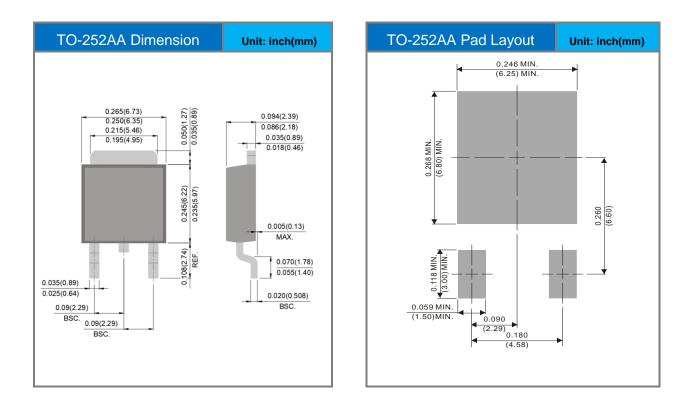




Product and Packing Information

Part No.	Package Type	Packing Type	Marking	
PCDD0865GB	TO-252AA	3,000 pcs / 13" reel	CDD0865B	

Packaging Information & Mounting Pad Layout





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